

C1206C822F5GACTU

Aliases (C1206C822F5GAC7800) SMD Comm COG, Ceramic, 8,200 pF, 1%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	20 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	0.9mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm
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W	1.6mm +/-0.2mm	Tolerance	1%
Т	0.9mm +/-0.10mm	Voltage DC	50 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.5mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/C, 1kHz 1.0Vr
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity	4000	Discipation Factor	0.10/ 1.1.1.1.1.0\ /

Specifications	
Capacitance	8,200 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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